

# DBIA WESTERN PACIFIC REGION College Scholarship Application

Application Deadline: April 15, 2013

# TERMS, CONDITIONS AND ELIGIBILITY CRITERIA

**Purpose:** The scholarship is designed to recognize and encourage excellence in the Design-Build approach to Design and Construction. The scholarship is awarded based on merit/academic achievement, demonstrated interest in & understanding of the Design-Build methodology, leadership skills, and financial need. Awards to be made on May 6, 2013 and winners will be invited to attend the DBIA Western Pacific Awards banquet on May 23, 2013. **Please submit questions to:** <u>dboughner@pankow.com</u>

## Scholarships Available: Plus the cost of travel and lodging to attend award ceremony.

• (8) Eight \$5,000.00 DBIA Western Pacific Region Scholarships

## **Required Application Documentation**

- Application Form
- Written Endorsement from Professor, Industry Professional or DBIA Member.
- Written Essay (3-Pages Maximum, 12 point font, 1.5 lines spacing, Times New Roman). Topic: How would you explain (or sell) the idea of using DB to a private sector Owner? Essay should incorporate: (1) A demonstrated interest in Design-Build (2) A passion for collaboration and innovation (3) How all members of the DB team (builders, designers, owners) work together in taking a project from creative design to constructed reality.
- Resume
- Short Autobiography (500 words maximum) including how you plan to use your DB education in your future endeavors.
- Submit one Electronic file containing all required documentation in PDF format, not to exceed 7-MB.

#### **Required Documentation** (Scholarship Winners only)

- Transcripts (in PDF format only, NO links to other sources)
- Proof of Tuition

#### **College/Enrollment Status**

• Candidates must be enrolled in a trade school, community college or university in the Western Pacific Region of the U.S. (Arizona, California, Hawaii, or Nevada). Graduate students are welcome to apply.

#### **Academic Requirements**

- Student in good standing making reasonable progress towards a degree in Design and/or Construction.
- 2.5 minimum cumulative G.P.A. (through latest grading period).
- Construction Management, Civil Engineering, Mechanical Engineering, Electrical Engineering, Architectural Engineering, Architecture, Landscape Architect, Interior Design, or other major pertinent to Design and Construction.
- Demonstrated interest in Design-Build through internship, project work, or participation in DBIA Student Chapter.
- We highly encourage all Applicants to be a student member of DBIA (Local student chapter or DBIA student member). If you are not already a member, or need assistance on becoming a member, please visit the DBIA website at: <a href="http://www.dbia.org/membership/individual/">http://www.dbia.org/membership/individual/</a>
- Leadership positions/activities on campus and/or community service activities, particularly those that relate to design and construction, to be considered.

#### **Financial Need**

• Financial need will be a criterion considered.

#### Terms

- Scholarship Recipients to receive funds in 2 equal installments: 1<sup>st</sup> half at the beginning of the school year (September 2013) and the second half at the end of the school year (May 2014).
- Scholarship Award will be paid directly to the student.



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#### Applicant:

- 1. Please read terms, conditions and requirements from page 1 before completing application form.
- Complete Section 1 below and sign where indicated.
- 2. 3. Email application and required documentation in one PDF file (7-MB Max) to Debbie Boughner at dboughner@pankow.com
- 4. Submit all questions by 4/1/13 to: dboughner@pankow.com

# (Section 1: To Be Completed By Applicant)

Student's Name: Last	First	Middle	Home Phone Number	
Mailing Address: Number/Street	City	State	Zip Code	Email Address
Name of College / University	Ca	ampus City/State	Gra	de Level
-	Najor, identify Major I	-		GPA
List below all scholarships, grants include dollar amounts	or other form of tuiti	on ald or assista	nce that you cu	rrently receive and
List below all construction industry chapters, community service or gro (Also attach your resume)				
Applicant Signature		Date	9	
Aŗ	oplicant: Please do n	ot write below th	is line.	
(Se	ection 2: To Be Completed	I By Scholarship Con	nmittee)	
Date Received:	Tuition Amount: \$	GP	4	
Eligibility Confirmation:  Qualify Proof of Tuition Letter of	ring School & Major		eceived 🗌 1	